# **Si4226DY**

# Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	25			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		26		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 4		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	0.6		2.0	V
Gate Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V			1	μΑ
		V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	20			Α
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.0155	0.0195	Ω
		$V_{GS} = 2.5 \text{ V}, I_D = 5 \text{ A}$		0.020	0.026	
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 7 A		40		S
Dynamic <sup>a</sup>				l	ı	
Input Capacitance	C <sub>iss</sub>	N-Channel V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1255		pF
Output Capacitance	C <sub>oss</sub>			185		
Reverse Transfer Capacitance	C <sub>rss</sub>			90		
Total Cata Charge		V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A		24	36	
Total Gate Charge	$Q_g$	N-Channel V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 8 A		11	17	nC
Gate-Source Charge	$Q_{gs}$			2		
Gate-Drain Charge	Q <sub>gd</sub>			2.5		
Gate Resistance	$R_g$	f = 1 MHz	0.3	1.4	2.8	Ω
Turn-On Delay Time	t <sub>d(on)</sub>	N-Channel $V_{DD} = 15 \text{ V, } R_L = 3 \Omega$ $I_D \cong 5 \text{ A, } V_{GEN} = 4.5 \text{ V, } R_g = 1 \Omega$		8	16	- ns
Rise Time	t <sub>r</sub>			9	18	
Turn-Off Delay Time	t <sub>d(off)</sub>			24	40	
Fall Time	t <sub>f</sub>			8	16	
Turn-On Delay Time	t <sub>d(on)</sub>	N-Channel $V_{DD} = 15 \text{ V, } R_L = 3 \Omega$ $I_D \cong 5 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 1 \Omega$		14	25	
Rise Time	t <sub>r</sub>			10	20	
Turn-Off Delay Time	t <sub>d(off)</sub>			30	50	
Fall Time	t <sub>f</sub>			8	16	
<b>Drain-Source Body Diode Characteristi</b>	cs					
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			2.6	- A
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				30	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2 A		0.73	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	N-Channel $I_F = 10$ A, $dI/dt = 100$ A/ $\mu$ s, $T_J = 25$ °C		25	50	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			14	28	nC
Reverse Recovery Fall Time	t <sub>a</sub>			12		ns
Reverse Recovery Rise Time	t <sub>b</sub>			13	İ	

#### Notes:

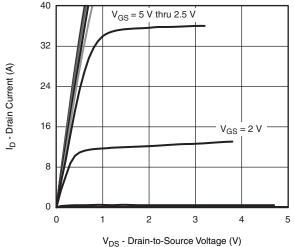
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

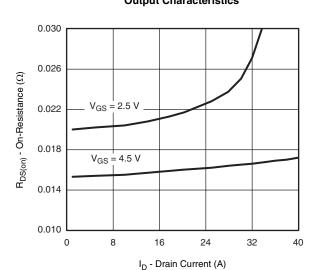


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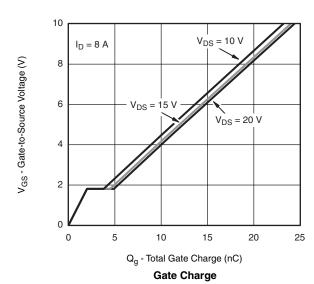
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



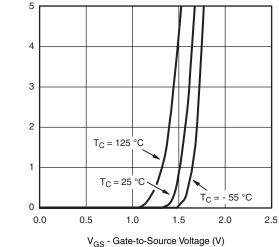
Output Characteristics



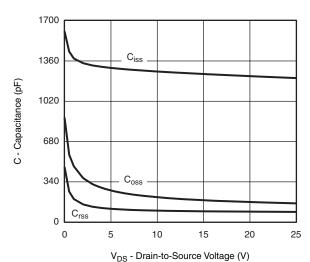
On-Resistance vs. Drain Current



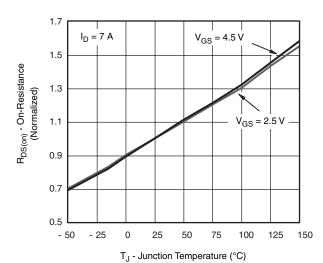
I<sub>D</sub> - Drain Current (A)



**Transfer Characteristics** 



Capacitance



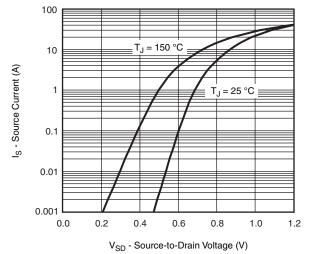
On-Resistance vs. Junction Temperature

## **Si4226DY**

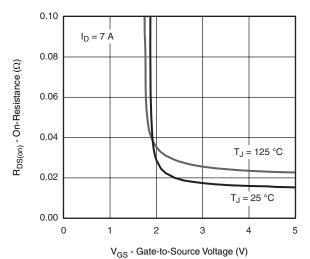
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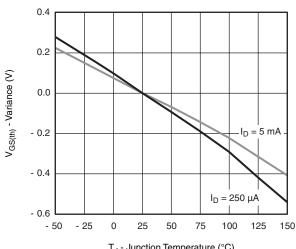
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

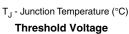


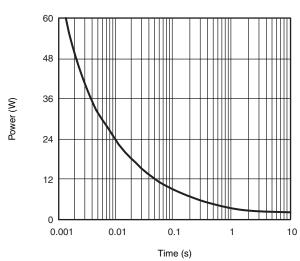
Source-Drain Diode Forward Voltage



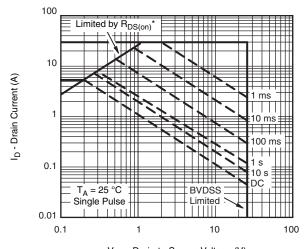
On-Resistance vs. Gate-to-Source Voltage







Single Pulse Power, Junction-to-Ambient



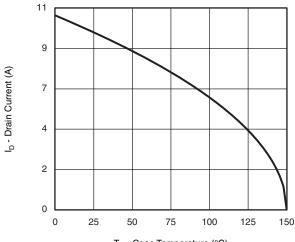
 $\label{eq:VDS} V_{DS} \text{ - Drain-to-Source Voltage (V)} \\ ^* V_{DS} \text{ > minimum } V_{GS} \text{ at which } R_{DS(on)} \text{ is specified}$ 

Safe Operating Area



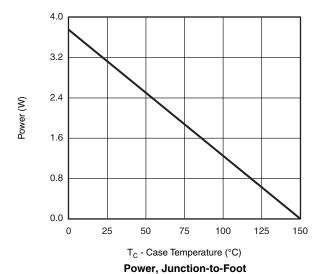
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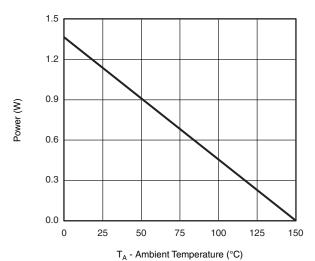
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 $T_C$  - Case Temperature (°C)

#### **Current Derating\***





Power Derating, Junction-to-Ambient

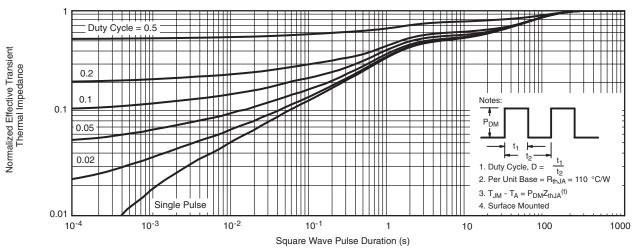
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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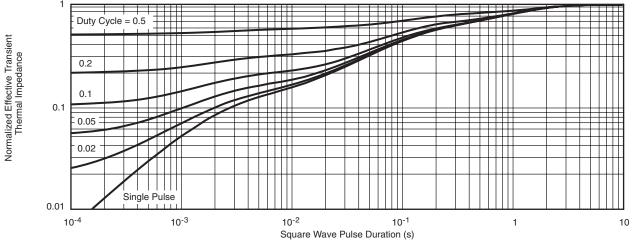
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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